

Features

- 1700-Volt Schottky Rectifier
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching
- Halogen-Free; RoHS Compliant

Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway



Part Number	Package	Marking
HC3D10170H	TO247-2L	HC3D10170H

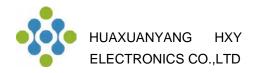
Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions	Note
V _{RRM}	Repetitive Peak Reverse Voltage	1700	v		
V _{RSM}	Surge Peak Reverse Voltage	1700	V		
V _{DC}	DC Blocking Voltage	1700	V		
I _F	Continuous Forward Current	14.4	А	T _c <135°C	
\mathbf{I}_{FRM}	Repetitive Peak Forward Surge Current	45 26	А	$T_c=25$ °C, $t_p=10$ ms, Half Sine Wave, D=1 $T_c=110$ °C, $t_p=10$ ms, Half Sine Wave, D=1	
\mathbf{I}_{FSM}	Non-Repetitive Peak Forward Surge Current	55 41	А	$T_c=25$ °C, $t_p=10$ ms, Half Sine Wave, D=1 $T_c=110$ °C, $t_p=10$ ms, Half Sine Wave, D=1	
P_{tot}	Power Dissipation	231 100	w	$T_c=25$ °C $T_c=110$ °C	
T _c	Maximum Case Temperature	135	°c		
T,	Operating Junction Range	-55 to +175	°C		
T _{stg}	Storage Temperature Range	-55 to +135	°C		
	TO-247 Mounting Torque	1 8.8	Nm lbf-in	M3 Screw 6-32 Screw	









Electrical Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V _F	Forward Voltage	1.7 3	2 3.5	V	$I_F = 10 \text{ A } T_J = 25^{\circ}\text{C}$ $I_F = 10 \text{ A } T_J = 175^{\circ}\text{C}$	
I _R	Reverse Current	20 100	60 300	μA	V _R = 1700 V T _J =25°C V _R = 1700 V T _J =175°C	
Q _c	Total Capacitive Charge	96		nC	$V_{R} = 1700 V, I_{F} = 10 A$ $di/dt = 200 A/\mu s$ $T_{J} = 25^{\circ}C$	
С	Total Capacitance	827 78 41		pF	$ \begin{array}{l} V_{_R} = 0 \ V, \ T_{_J} = 25^{\circ}C, \ f = 1 \ MHz \\ V_{_R} = 200 \ V, \ T_{_J} = 25^{\circ}C, \ f = 1 \ MHz \\ V_{_R} = 800 \ V, \ T_{_J} = 25^{\circ}C, \ f = 1 \ MHz \end{array} $	

Note:

1. This is a majority carrier diode, so there is no reverse recovery charge.

Thermal Characteristics

Symbol	Parameter	Тур.	Unit
$R_{_{\theta JC}}$	Thermal Resistance from Junction to Case	0.65	°C/W

Typical Performance

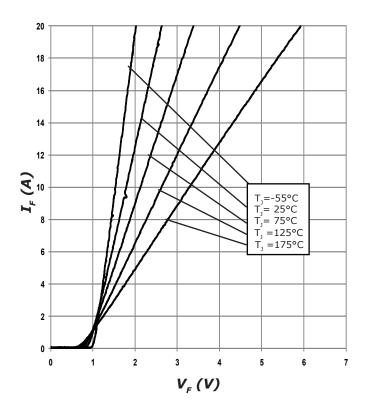


Figure 1. Forward Characteristics

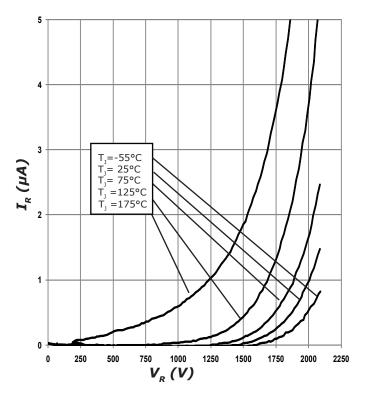
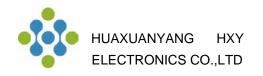
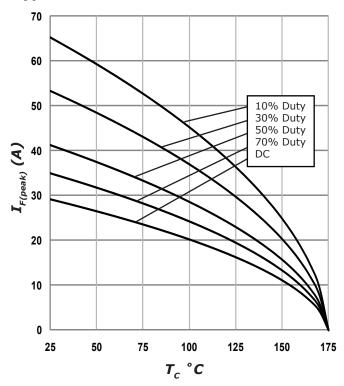


Figure 2. Reverse Characteristics



175

Typical Performance



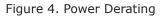
 $P_{Tot}(W)$ 50 0 25 75 100 50 125 150 $\boldsymbol{\tau}_c \ ^{\circ}\boldsymbol{C}$

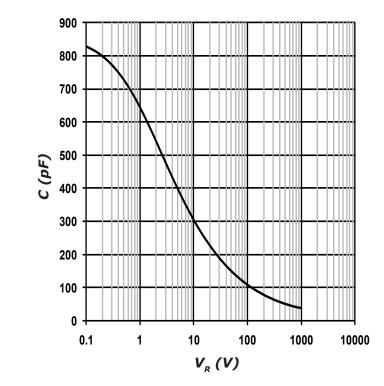
250

200

150

100





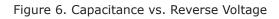


Figure 3. Current Derating

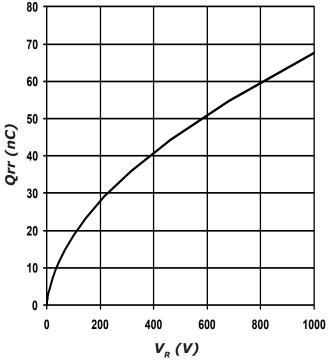
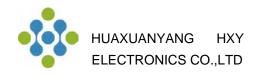


Figure 5. Recovery Charge vs. Reverse Voltage



Typical Performance

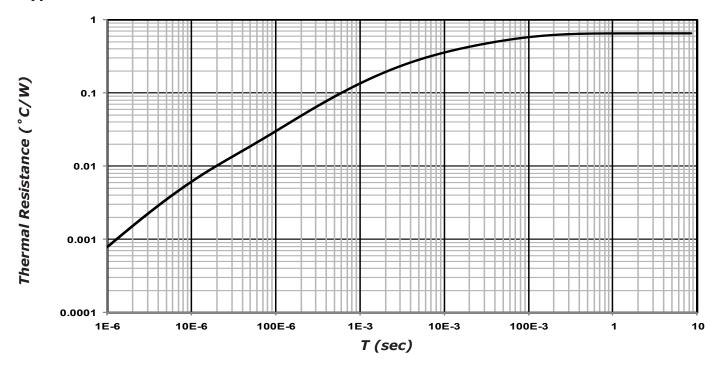
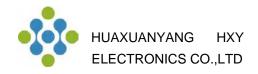


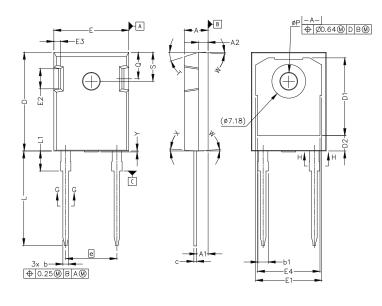
Figure 7. Transient Thermal Impedance



Package Dimensions

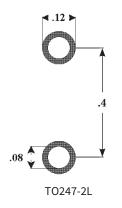
Package: TO247-2L

All dimensions in mm.

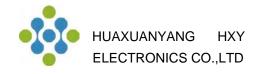


	MILLIM	ETERS	INCHES				
SYM	MIN	MAX	MIN	MAX			
А	4.83	5.21	.190	.205			
Al	2.29	2.54	.090	.100			
A2	1.91	2.16	.075	.085			
b'	1.07	1.28	.042	.050			
b	1.07	1.33	.042	.052			
b1	1.91	2.41	.075	.095			
b2	1.91	2.16	.075	.085			
c'	0.55	0.65	.022	.026			
с	0.55	0.68	.022	.027			
D	20.80	21.10	.819	.831			
D1	16.25	17.35	.640	.683			
D2	2.86	3.16	.112	.124			
Е	15.75	16.13	.620	.635			
E1	13.10	14.15	.516	.557			
E2	3.68	5.10	.145	.201			
E3	1.00	1.90	.039	.075			
E4	12.38	13.43	.487	.529			
e	10.88	BSC	.428 BSC				
L	19.81	20.32	.780	.800			
Ll	4.10	4.40	.161	.173			
ØР	3.51	3.65	.138	.144			
Q	5.49	6.00	.216	.236			
S	6.04	6.30	.238	.248			
Т		17.5° REF.					
W		3.5° REF.					
Х		4° REF.					
Y	0	0.50	0	0.020			

Recommended Solder Pad Layout



all units are in inches



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